

3SM122KZT1VA MEMS Microphone IC

Product Description

The *3SM122KZT1VA* microphone IC are integrated with specialized pre-amplification ASIC to provide high sensitivity, high SNR output from a capacitive audio sensor. It's packaged for surface mounting and high temperature reflow assembly. *3SM122KZT1VA* which is able to endure reflow temperature up to 260°C for 30 seconds can be used in SMT process. It is widely used in telecommunication and electronics device such as headset, wearable device.

Features

- Top port
- High stability - no risk of membrane aging
- Suitable for automatic pick-and-place handler and SMT process
- Miniature dimension 2.75mm x 1.85mm x 1.05mm
- Low current consumption 80uA
- RoHS/Green compliant
- Sensitivity deviation within ± 1 dB
- Package type : LGA 4-pin
- Omnidirectional

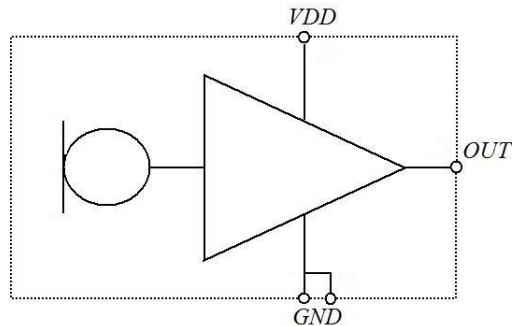
Applications

- ANC Headsets
- TWS Headsets
- Wearable Devices
- IoT Devices

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Functional Block Diagram



Pin Definition and Function

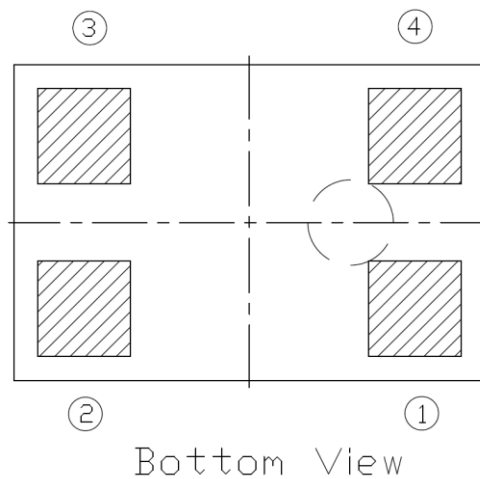


Table 1

Pin #	Symbol	Function
1	OUTPUT	Analog signal output
2	GND	Ground
3	GND	Ground
4	VDD	Power supply

Temperature Range

Table 2

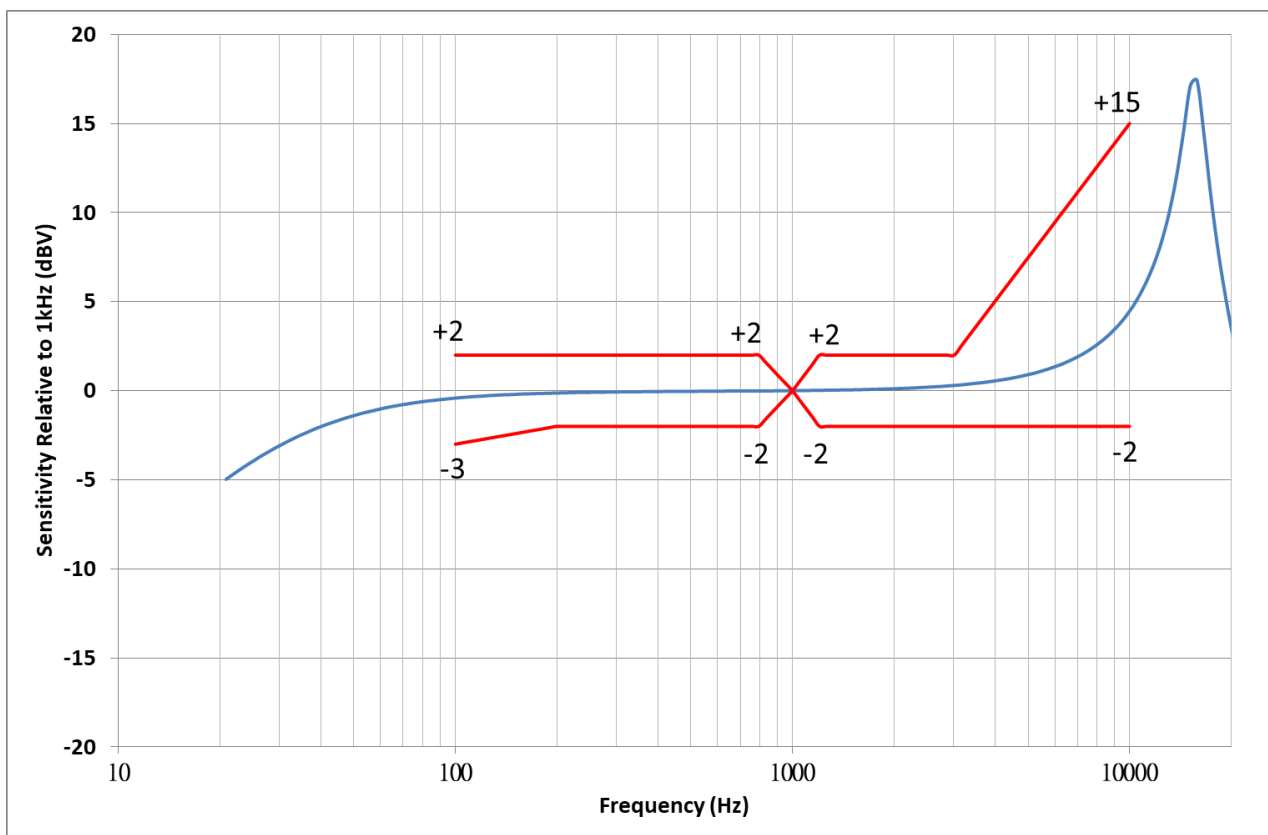
Storage Temperature	T_{STG}	-40°C ~ 125°C
Operating Temperature Range	T_A	-40°C ~ 105°C

Acoustical and Electrical Characteristics

Table 3 Typical test conditions are $T_A = 23\text{ }^\circ\text{C}$, $V_{DD} = 2.1\text{ V}$ and $R.H. = 50\%$ measured in a pressure chamber test setup. All voltages refer to GND node

Parameters	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Acoustic						
Sensitivity	S	-39	-38	-37	dBV/Pa	1KHz, 94dB SPL
Signal to Noise Ratio	S/N		64		dB	A-weighted
Equivalent Noise Level	ENL		30		dB	A-weighted
Total Harmonic Distortion	THD		0.1		%	94dB SPL
			1		%	120dB SPL
Acoustic Overload Point	AOP		128		dB SPL	10% THD@1KHz, S = Typ.
Low Frequency Roll-off	LFRO		30		Hz	-3dB relative to 1KHz
Electrical						
Supply Voltage	V _{dd}	1.6		3.6	V	
Current Consumption	I _{sb}		80		μA	V _{dd} =2.1V
			80		μA	V _{dd} =3.6V
Power Supply Rejection	PSR+N		-93		dBV(A)	217Hz, 100 mV peak to peak square wave on V _{cc} 2.1V
Power Supply Rejection Ratio	PSRR		63		dB	1KHz, 200 mV peak to peak sine wave on V _{cc} 2.1V
Output Impedance	Z _{out}			200	Ω	@1KHz
Output DC Offset			1.3		V	
Directivity	Omnidirectional					
Polarity	Increasing output voltage					Increasing sound pressure

Frequency Response



Typical frequency response normalized to 1KHz (Measured)

Upper Limit						
Hz	100	800	1000	1200	3000	10000
dB ref. 1KHz	+2	+2	0	+2	+2	+15
Lower Limit						
Hz	100	200	800	1000	1200	10000
dB ref. 1KHz	-3	-2	-2	0	-2	-2

Reliability Qualifications

Table 4

Test Item	Description
High Temperature Storage	Storage at 125°C for 1,000 hours IEC 60068-2-2 Test Ba
Low Temperature Storage	Storage at -40°C for 1,000 hours IEC 60068-2-1 Test Aa
High Temperature Operation Bias	Under Bias at 105°C for , 1,000 hours IEC 60068-2-2 Test Ba
Low Temperature Operation Bias	Under Bias at -40°C for , 1,000 hours IEC 60068-2-1 Test Aa
Temperature Humidity Bias	Under Bias at 85°C/85%RH for 1,000 hours JESD22-A101-B
Thermal Shock	Thermal Shock 100 cycles from -40°C~125°C, 100 cycles IEC 60068-2-14
Reflow	3 reflow cycles with peak 260°C J-STD-020D
Vibration	4 cycles lasting 12 minutes from 20 to 2KHz in X, Y and Z with peak acceleration of 20G MIL 883E, Method 2007.2, A
Shock	3 pulses 10,000G in X,Y and Z IEC 60068-2-27, Test Ea
ESD	HBM:3KV, MM:300V, CDM:500V Air Discharge:15KV, Contact Discharg:8KV JESD22-A114(HBM); JESD22-A115(MM) JESD22-C101(CDM) IEC 61000-4-2(Air Discharge) IEC 61000-4-2(Contact Discharge)
Tumble test	300 tumbles from a height of 1m onto a steel base.

Notes: Microphones meet all acoustic and electrical specifications before and after reliability testing, except sensitivity which can deviate up to 3dB.

After 3 reflow cycles, the sensitivity of the microphone shall not deviate more than 1 dB from its initial value

Reflow Profile

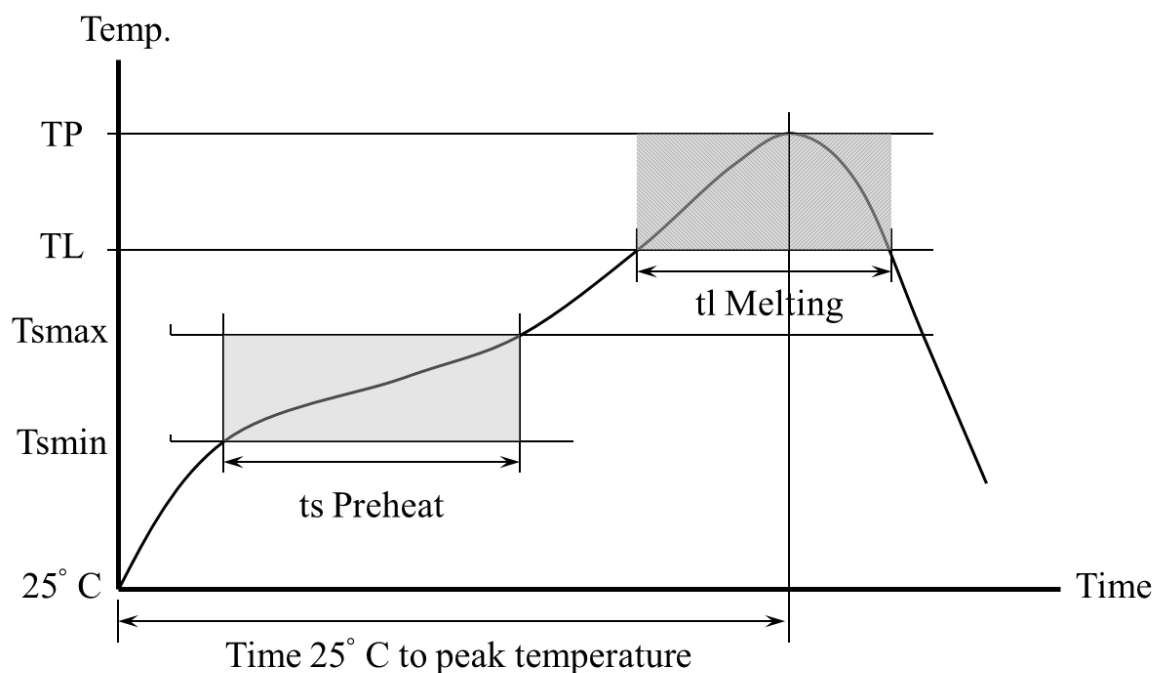


Table 5. Recommended Reflow Profile Limits

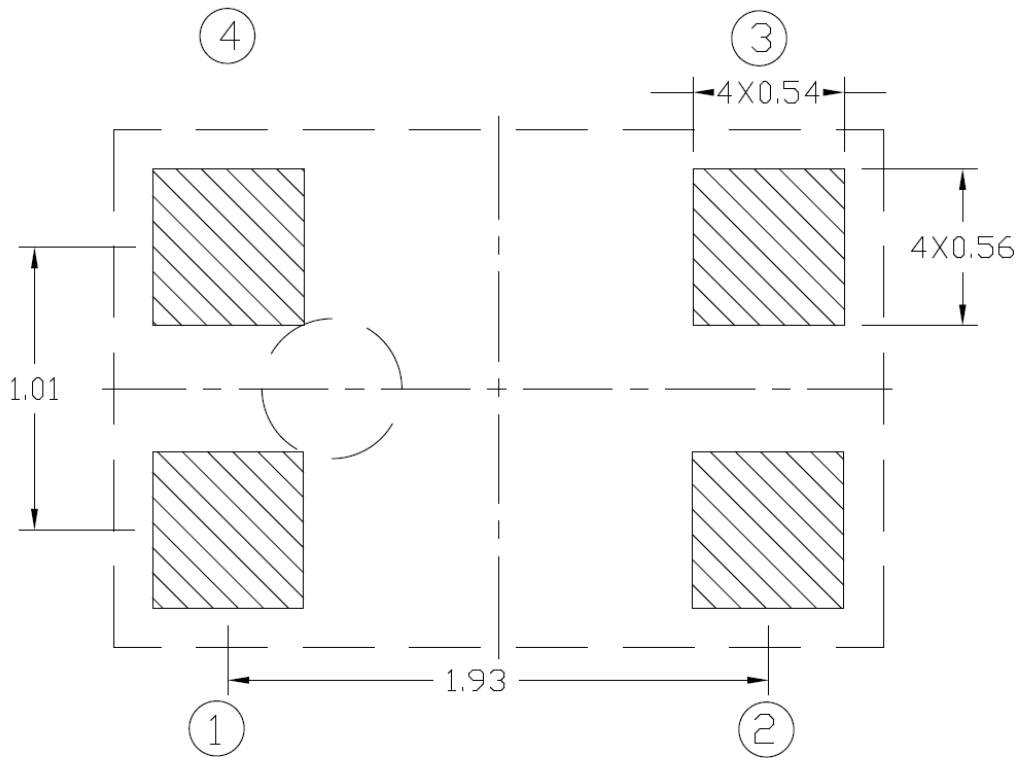
Profile Feature	Pb-free
Preheat	
Minimum temperature (T_{smin})	150 °C
Maximum temperature (T_{smax})	200 °C
Time (t_s)	60~180 sec
Average Ramp up rate (T_{smax} to T_p)	3 °C/sec
Melting area	
Melting temperature (T_L)	217 °C
Time maintained above melting (t_l)	60~150 sec
Peak Temperature (T_P)	260 °C
Time within 5°C of actual peak temperature	20~40 sec
Ramp down rate	6 °C/sec maximum
Time 25°C to peak temperature	8 minute maximum

Notes: Based on IPC/JDEC J-STD-020 Revision C.

All temperatures refer to topside of the package, measured on the package body surface.

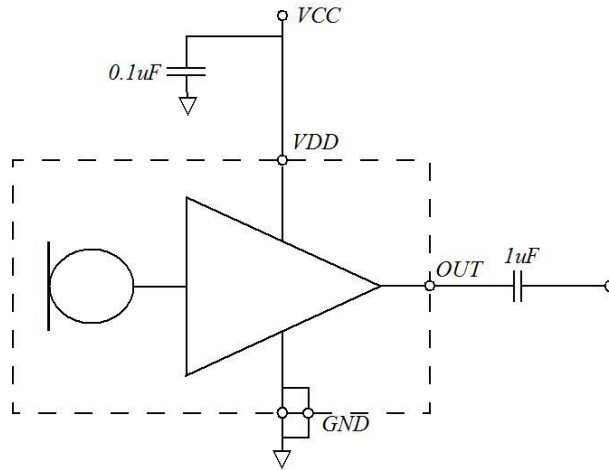
PCB Land Pattern Layout

Recommended Land Pattern



Application Circuit

Typical Application:



Handling Instructions

The MEMS microphone IC can be handled using standard pick-and-place and chip-shooting equipment. Care should be taken to avoid damage to the MEMS microphone IC structure as follows:

- Do not apply vacuum nozzle over the acoustic port (AP) of the microphone to avoid damage to the device.
- Do not blow air directly into acoustic port. If air gun cleaning is required, the minimum distance is 10cm and the maximum air blow pressure is 30psi.
- Brushing the board with/without solvents may damage the device.
- Do not use excessive force to place the microphone on the PCB.
- In case of manual handling, it should be handled with plastic tweezers to avoid damage to the device.
- Do not open and remove IC from packaging until devices are ready to be mounted.
- Suggest PCB depaneling be done with depaneling cutter/router, or manually de-panel PCB with care and without any contact of MEMS Microphone IC.

Dimensions

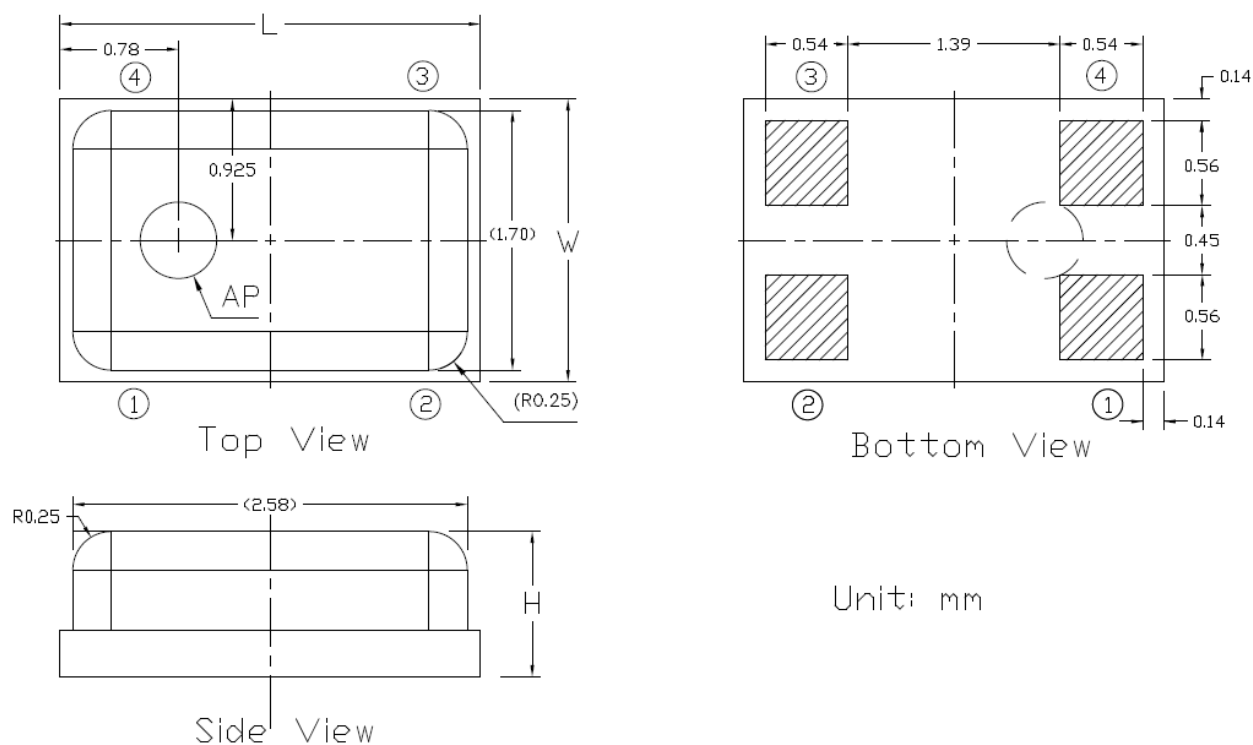
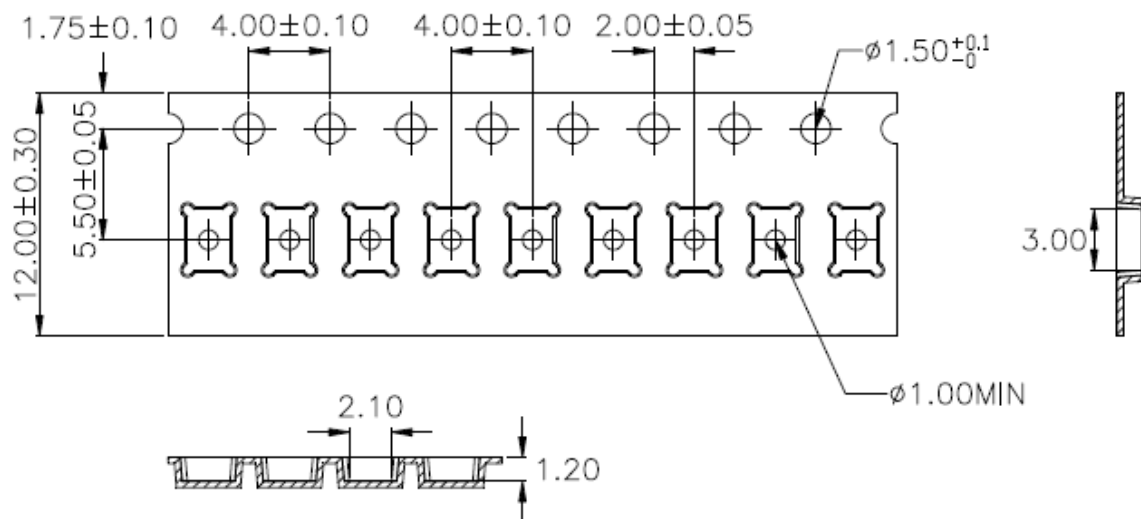


Table 6(Top View)

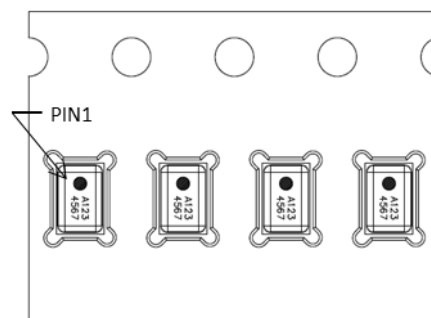
Item	Dimension	Tolerance
Length (L)	2.75 mm	±0.10 mm
Width (W)	1.85 mm	±0.10 mm
Height (H)	1.05 mm	±0.10 mm
Acoustic Port	Φ 0.50 mm	±0.05 mm

Package Information

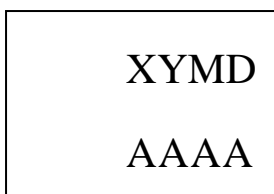
Carrier Tape:



1. 10 sprocket hole pitch cumulative tolerance ± 0.20 .
2. Carrier camber is within 1 mm in 250 mm.
3. Material : Black Conductive Polystyrene Alloy.
4. All dimensions meet EIA-481 requirements.
5. Thickness : 0.30 ± 0.05 mm.
6. MSL(Moisture sensitivity level) Class1.

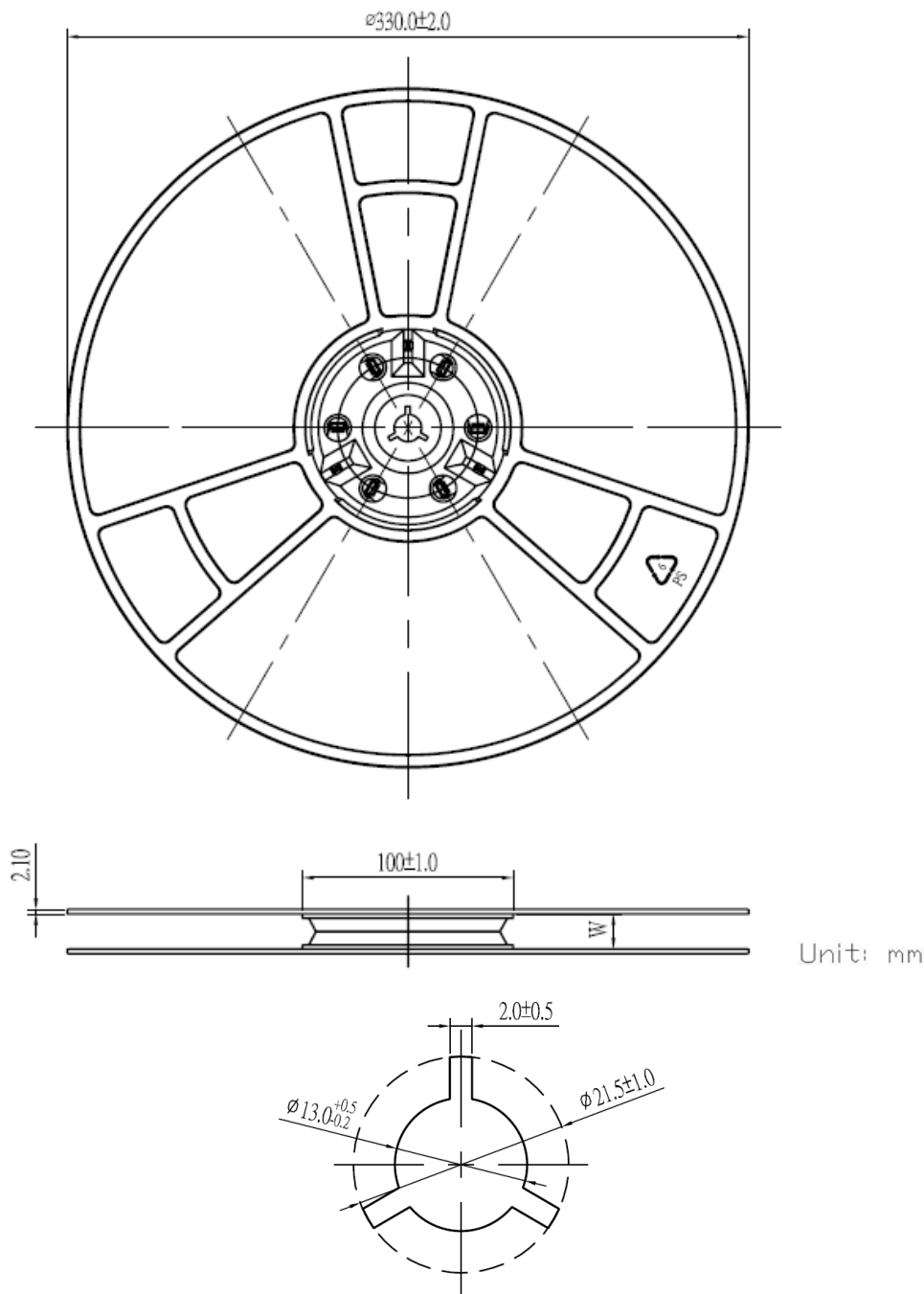


Laser Marking:



Laser marking on the top side

XYMD	Internal Tracking Code(X:Subject to change without notice) Date Code(Y:Year; M:Month; D:Day)
AAAA	Lot Tracking Code

13" Tape Reel :


Model Number	Reel Diameter	Quantity Per Reel
3SM122KZT1VA	13"	5,000

Revision History

Revision	Date	Description
1.0	2020/04/08	Formal release
1.1	2020/07/08	Modify “Features” Modify “Acoustical and Electrical Characteristics” Modify “Frequency Response” Modify “Reliability Qualifications” Modify “Reflow Profile”
1.2	2020/08/27	Modify “Product Description”
1.3	2020/12/21	Add “Laser Marking”
1.4	2021/07/06	Modify “Acoustical and Electrical Characteristics” Modify “Frequency Response” Modify “Reliability Qualifications” Modify “Package Information”